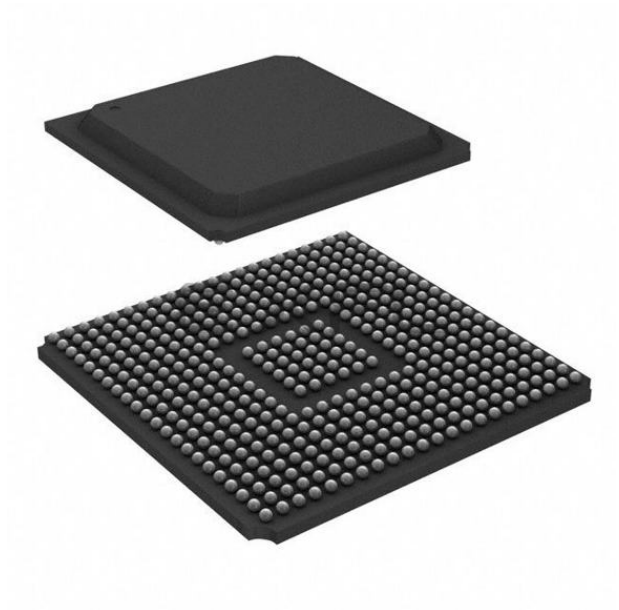

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Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	1232
Number of Logic Elements/Cells	11088
Total RAM Bits	811008
Number of I/O	248
Number of Gates	-
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	456-BBGA
Supplier Device Package	456-FBGA (23x23)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc2vp7-7fgg456c

Functional Description: RocketIO X Multi-Gigabit Transceiver (MGT)

This section summarizes the features of the RocketIO X multi-gigabit transceiver. For an in-depth discussion of the RocketIO X MGT, including digital and analog design considerations, refer to the **RocketIO X Transceiver User Guide.**

RocketIO X Overview

Either eight or twenty RocketIO X MGTs are available on the XC2VPX20 and XC2VPX70 devices, respectively. The XC2VPX20 MGT is designed to operate at any baud rate in the range of 2.488 Gb/s to 6.25 Gb/s per channel. This includes specific baud rates used by various standards as listed in Table 1. The XC2VPX70 MGT operates at a fixed 4.25 Gb/s per channel.

The RocketIO X MGT consists of the *Physical Media Attachment* (PMA) and *Physical Coding Sublayer* (PCS). The PMA contains the 6.25 Gb/s serializer/deserializer (SERDES), TX/RX buffers, clock generator, and clock recovery circuitry. The RocketIO X PCS has been significantly updated relative to the RocketIO PCS. In addition to the existing RocketIO PCS features, the RocketIO X PCS features 64B/66B encoder/decoder/scrambler/descrambler and SONET compatibility.

See Table 7, page 17, for a summary of the differences between the RocketIO X PMA/PCS and the RocketIO PMA/PCS.

Figure 4, page 3 shows a high-level block diagram of the RocketIO X transceiver and its FPGA interface signals.

Table 1: **Communications Standards Supported by RocketIO X Transceiver**(2)

Mode	Channels (Lanes)(1)	I/O Bit Rate (Gb/s)
SONET OC-48	1	2.488
PCI Express	1, 2, 4, 8, 16	2.5
Infiniband	1, 4, 12	2.5
XAUI (10-Gb Ethernet)	4	3.125
XAUI (10-Gb Fibre Channel)	4	3.1875
Aurora (Xilinx protocol)	1, 2, 3, 4,...	2.488 to 6.25
Custom Mode	1, 2, 3, 4,...	2.488 to 6.25

Notes:
1. One channel is considered to be one transceiver.
2. XC2VPX70 operates at a fixed 4.25 Gb/s baud rate.

PMA

Transmitter Output

The RocketIO X transceiver is implemented in *Current Mode Logic* (CML). A CML transmitter output consists of transistors configured as shown in Figure 2. CML uses a positive supply and offers easy interface requirements. In this configuration, both legs of the driver, VP and VN, sink current, with one leg always sinking more current than its complement. The CML output consists of a differential pair with 50Ω source resistors. The signal swing is created by switching the current in a common-source differential pair.

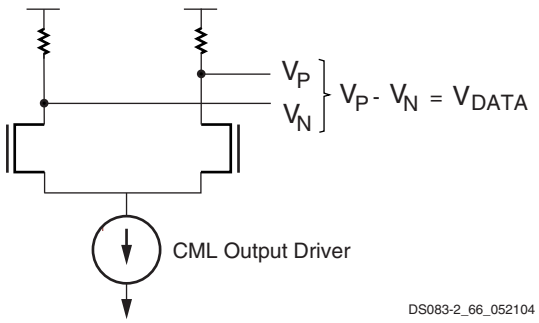

Figure 2: **CML Output Configuration**

Transmitter Termination

On-chip termination is provided at the transmitter, eliminating the need for external termination. The output driver and termination are powered by V_{TTX} at 1.5V. This configuration uses a CML approach with 50Ω termination to TXP and TXN as shown in Figure 3.

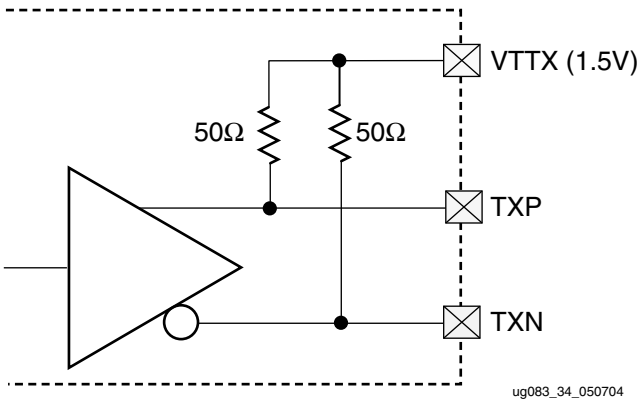

Figure 3: **RocketIO X Transmit Termination**

Functional Description: RocketIO Multi-Gigabit Transceiver (MGT)

This section summarizes the features of the RocketIO multi-gigabit transceiver. For an in-depth discussion of the RocketIO MGT, including digital and analog design considerations, refer to the ***RocketIO Transceiver User Guide***.

RocketIO Overview

Up to twenty RocketIO MGTs are available. The MGT is designed to operate at any baud rate in the range of 622 Mb/s to 3.125 Gb/s per channel. This includes specific baud rates used by various standards as listed in Table 4.

The RocketIO MGT consists of the *Physical Media Attachment* (PMA) and *Physical Coding Sublayer* (PCS). The PMA contains the 3.125 Gb/s serializer/deserializer (SERDES), TX/RX buffers, clock generator, and clock recovery circuitry. The PCS contains the bypassable 8B/10B encoder/ decoder, elastic buffers, and Cyclic Redundancy Check (CRC) units. The encoder and decoder handle the 8B/10B coding scheme. The elastic buffers support the clock correction (rate matching) and channel bonding features. The CRC units perform CRC generation and checking.

See Table 7, page 17, for a summary of the differences between the RocketIO X PMA/PCS and the RocketIO PMA/PCS.

Figure 10, page 11 shows a high-level block diagram of the RocketIO transceiver and its FPGA interface signals.

Table 4: **Protocols Supported by RocketIO Transceiver**

Mode	Channels (Lanes)(1)	I/O Bit Rate (Gb/s)
Fibre Channel	1	1.06
		2.12
		3.1875 (2)
Gigabit Ethernet	1	1.25
10Gbit Ethernet	4	3.125
Infiniband	1, 4, 12	2.5
Aurora	1, 2, 3, 4, ...	0.622 – 3.125
Custom Protocol	1, 2, 3, 4, ...	up to 3.125

Notes:
1. One channel is considered to be one transceiver.
2. Virtex-II Pro MGT can support the 10G Fibre Channel data rates of 3.1875 Gb/s across 6" of standard FR-4 PCB and one connector (Molex 74441 or equivalent) with a bit error rate of 10^{-12} or better.

PMA

Transmitter Output

The RocketIO transceiver is implemented in *Current Mode Logic* (CML). A CML transmitter output consists of transistors configured as shown in Figure 8. CML uses a positive supply and offers easy interface requirements. In this configuration, both legs of the driver, VP and VN, sink current, with one leg always sinking more current than its complement. The CML output consists of a differential pair with 50Ω (or, optionally, 75Ω) source resistors. The signal swing is created by switching the current in a common-source differential pair.

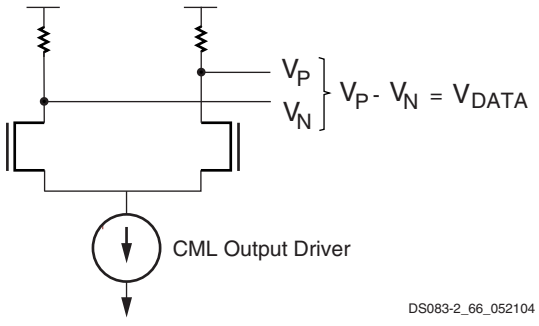

Figure 8: **CML Output Configuration**

Transmitter Termination

On-chip termination is provided at the transmitter, eliminating the need for external termination. The output driver and termination are powered by V_{TTX}. This configuration uses a CML approach with selectable 50Ω or 75Ω termination to TXP and TXN as shown in Figure 9.

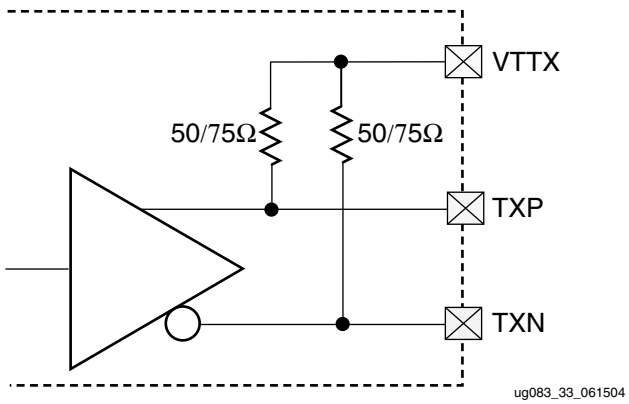

Figure 9: **RocketIO Transmit Termination**

Table 11: **LVCMOS Programmable Currents (Sink and Source)**

SelectIO-Ultra	Programmable Current (Worst-Case Guaranteed Minimum)						
LVTTL	2 mA	4 mA	6 mA	8 mA	12 mA	16 mA	24 mA
LVCMOS33	2 mA	4 mA	6 mA	8 mA	12 mA	16 mA	24 mA
LVCMOS25	2 mA	4 mA	6 mA	8 mA	12 mA	16 mA	24 mA
LVCMOS18	2 mA	4 mA	6 mA	8 mA	12 mA	16 mA	n/a
LVCMOS15	2 mA	4 mA	6 mA	8 mA	12 mA	16 mA	n/a

Figure 23 shows the SSTL2, SSTL18, and HSTL configurations. HSTL can sink current up to 48 mA. (HSTL IV)

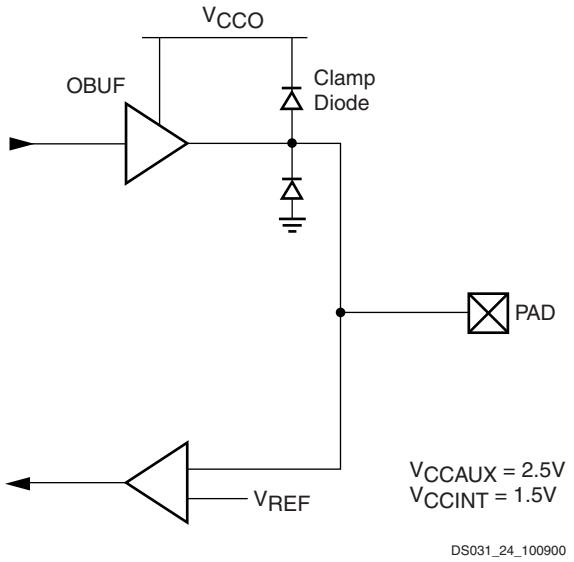

Figure 23: **SSTL or HSTL SelectIO-Ultra Standards**

All pads are protected against damage from electrostatic discharge (ESD) and from over-voltage transients. Virtex-II Pro uses two memory cells to control the configuration of an I/O as an input. This is to reduce the probability of an I/O configured as an input from flipping to an output when subjected to a single event upset (SEU) in space applications.

Prior to configuration, all outputs not involved in configuration are forced into their high-impedance state. The pull-down resistors and the weak-keeper circuits are inactive. The dedicated pin HSWAP_EN controls the pull-up resistors prior to configuration. By default, HSWAP_EN is set High, which disables the pull-up resistors on user I/O pins. When HSWAP_EN is set Low, the pull-up resistors are activated on user I/O pins.

All Virtex-II Pro IOBs (except RocketIO transceiver pins) support IEEE 1149.1 and IEEE 1532 compatible Boundary-Scan testing.

Input Path

The Virtex-II Pro IOB input path routes input signals directly to internal logic and / or through an optional input flip-flop or latch, or through the DDR input registers. An optional delay element at the D-input of the storage element eliminates pad-to-pad hold time. The delay is matched to the internal clock-distribution delay of the Virtex-II Pro device, and when used, assures that the pad-to-pad hold time is zero.

Each input buffer can be configured to conform to any of the low-voltage signaling standards supported. In some of these standards the input buffer utilizes a user-supplied threshold voltage, V_{REF}. The need to supply V_{REF} imposes constraints on which standards can be used in the same bank. See I/O banking description.

Output Path

The output path includes a 3-state output buffer that drives the output signal onto the pad. The output and / or the 3-state signal can be routed to the buffer directly from the internal logic or through an output / 3-state flip-flop or latch, or through the DDR output / 3-state registers.

Each output driver can be individually programmed for a wide range of low-voltage signaling standards. In most signaling standards, the output High voltage depends on an externally supplied V_{CCO} voltage. The need to supply V_{CCO} imposes constraints on which standards can be used in the same bank. See I/O banking description.

I/O Banking

Some of the I/O standards described above require V_{CCO} and V_{REF} voltages. These voltages are externally supplied and connected to device pins that serve groups of IOB blocks, called banks. Consequently, restrictions exist about which I/O standards can be combined within a given bank.

Eight I/O banks result from dividing each edge of the FPGA into two banks, as shown in Figure 24 and Figure 25. Each bank has multiple V_{CCO} pins, all of which must be connected to the same voltage. This voltage is determined by the output standards in use.

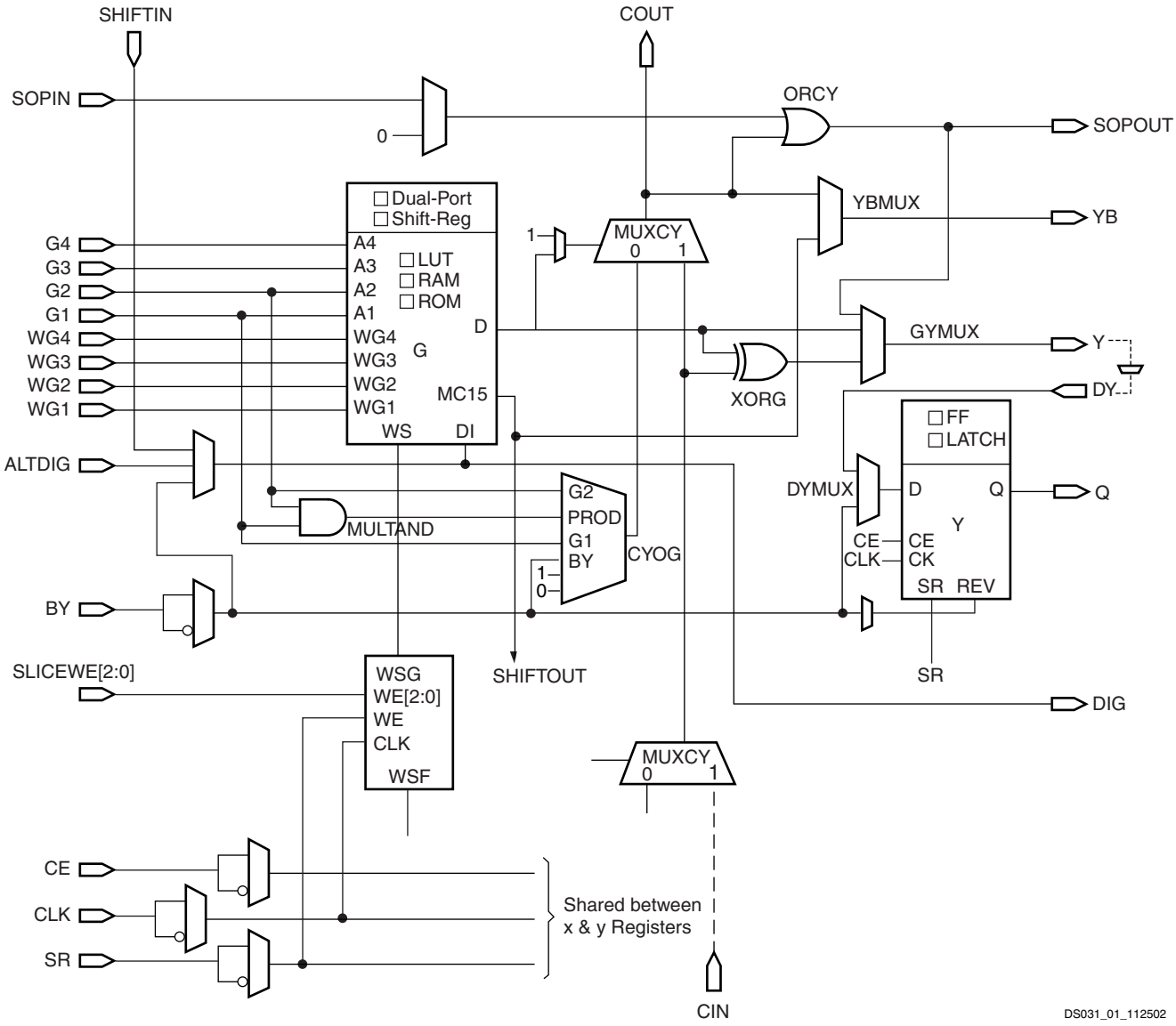

Figure 34: **Virtex-II Pro Slice (Top Half)**

Table 24: **RocketIO X Receiver Switching Characteristics**(1)

Description	Symbol	Conditions	Min	Typ	Max	Units
Receive total jitter tolerance using default equalization and PRBS-15 pattern	T_{JTOL}	2.488 Gb/s		0.80	0.65	UI(2)
		3.125 Gb/s		0.80	0.65	UI
		4.25 Gb/s		0.80	0.65	UI
		6.25 Gb/s		0.80	0.65	UI
Receive random jitter tolerance	T_{RJTOL}	2.488 Gb/s		0.30		UI
		3.125 Gb/s		0.30		UI
		4.25 Gb/s		0.30		UI
		6.25 Gb/s		0.30		UI
Receive sinusoidal jitter tolerance measured at 70 MHz	T_{SJTOL}	2.488 Gb/s		0.30	0.15	UI
		3.125 Gb/s		0.30	0.15	UI
		4.25 Gb/s		0.30	0.15	UI
		6.25 Gb/s		0.30	0.15	UI
Receive deterministic jitter tolerance	T_{DJTOL}	2.488 Gb/s		0.55	0.45	UI
		3.125 Gb/s		0.55	0.45	UI
		4.25 Gb/s		0.55	0.45	UI
		6.25 Gb/s		0.50	0.45	UI
Receive latency(3)	T_{RXLAT}			25	34(4)	RXUSRCLK cycles
RXUSRCLK duty cycle	T_{RXDC}		45	50	55	%
RXUSRCLK2 duty cycle	T_{RX2DC}		45	50	55	%
Differential receive input sensitivity	V_{EYE}			120	250	mV

Notes:
1. The XC2VPX70 operates at a fixed 4.25 Gb/s baud rate.
2. UI = Unit Interval
3. Receive latency delay RXP/RXN to RXDATA. Refer to ***RocketIO X Transceiver User Guide*** for more information on calculating latency.
4. This maximum may occur when certain conditions are present and clock correction and channel bonding are enabled. If these functions are both disabled, the maximum will be near the typical values.

Table 5: **FG256/FGG256 — XC2VP2 and XC2VP4**

Bank	Pin Description	Pin Number
7	IO_L85N_7	G2
7	IO_L06P_7	G3
7	IO_L06N_7	G4
7	IO_L04P_7	F1
7	IO_L04N_7/VREF_7	F2
7	IO_L03P_7	F3
7	IO_L03N_7	F4
7	IO_L02P_7	F5
7	IO_L02N_7	E4
7	IO_L01P_7/VRN_7	E2
7	IO_L01N_7/VRP_7	E3
0	VCCO_0	F8
0	VCCO_0	F7
0	VCCO_0	E8
1	VCCO_1	F9
1	VCCO_1	F10
1	VCCO_1	E9
2	VCCO_2	H12
2	VCCO_2	H11
2	VCCO_2	G11
3	VCCO_3	K11
3	VCCO_3	J12
3	VCCO_3	J11
4	VCCO_4	M9
4	VCCO_4	L9
4	VCCO_4	L10
5	VCCO_5	M8
5	VCCO_5	L8
5	VCCO_5	L7
6	VCCO_6	K6
6	VCCO_6	J6
6	VCCO_6	J5
7	VCCO_7	H6
7	VCCO_7	H5

FG456/FGG456 Fine-Pitch BGA Package

As shown in Table 6, XC2VP2, XC2VP4, and XC2VP7 Virtex-II Pro devices are available in the FG456/FGG456 fine-pitch BGA package. The pins in these devices are same, except for the differences shown in the "No Connects" column. Following this table are the FG456/FGG456 Fine-Pitch BGA Package Specifications (1.00mm pitch).

Table 6: **FG456/FGG456 — XC2VP2, XC2VP4, and XC2VP7**

Bank	Pin Description	Pin Number	No Connects		
			XC2VP2	XC2VP4	XC2VP7
0	IO_L01N_0/VRP_0	D5			
0	IO_L01P_0/VRN_0	D6			
0	IO_L02N_0	E6			
0	IO_L02P_0	E7			
0	IO_L03N_0	D7			
0	IO_L03P_0/VREF_0	C7			
0	IO_L05_0/No_Pair	E8			
0	IO_L06N_0	D8			
0	IO_L06P_0	C8			
0	IO_L07N_0	F9			
0	IO_L07P_0	E9			
0	IO_L09N_0	D9			
0	IO_L09P_0/VREF_0	D10			
0	IO_L67N_0	F10			
0	IO_L67P_0	E10			
0	IO_L69N_0	C10			
0	IO_L69P_0/VREF_0	B11			
0	IO_L74N_0/GCLK7P	F11			
0	IO_L74P_0/GCLK6S	E11			
0	IO_L75N_0/GCLK5P	D11			
0	IO_L75P_0/GCLK4S	C11			
1	IO_L75N_1/GCLK3P	C12			
1	IO_L75P_1/GCLK2S	D12			
1	IO_L74N_1/GCLK1P	E12			
1	IO_L74P_1/GCLK0S	F12			
1	IO_L69N_1/VREF_1	B12			
1	IO_L69P_1	C13			
1	IO_L67N_1	E13			
1	IO_L67P_1	F13			
1	IO_L09N_1/VREF_1	D13			
1	IO_L09P_1	D14			
1	IO_L07N_1	E14			

Table 6: **FG456/FGG456 — XC2VP2, XC2VP4, and XC2VP7**

Bank	Pin Description	Pin Number	No Connects		
			XC2VP2	XC2VP4	XC2VP7
4	IO_L69P_4/VREF_4	AA12			
4	IO_L74N_4/GCLK3S	U12			
4	IO_L74P_4/GCLK2P	V12			
4	IO_L75N_4/GCLK1S	W12			
4	IO_L75P_4/GCLK0P	Y12			
5	IO_L75N_5/GCLK7S	Y11			
5	IO_L75P_5/GCLK6P	W11			
5	IO_L74N_5/GCLK5S	V11			
5	IO_L74P_5/GCLK4P	U11			
5	IO_L69N_5/VREF_5	AA11			
5	IO_L69P_5	Y10			
5	IO_L67N_5	V10			
5	IO_L67P_5	U10			
5	IO_L09N_5/VREF_5	W10			
5	IO_L09P_5	W9			
5	IO_L07N_5/VREF_5	V9			
5	IO_L07P_5	U9			
5	IO_L06N_5/VRP_5	Y8			
5	IO_L06P_5/VRN_5	W8			
5	IO_L05_5/No_Pair	V8			
5	IO_L03N_5/D4	Y7			
5	IO_L03P_5/D5	W7			
5	IO_L02N_5/D6	V7			
5	IO_L02P_5/D7	V6			
5	IO_L01N_5/RDWR_B	W6			
5	IO_L01P_5/CS_B	W5			
6	IO_L01P_6/VRN_6	AB2			
6	IO_L01N_6/VRP_6	AA1			
6	IO_L02P_6	Y2			
6	IO_L02N_6	Y1			
6	IO_L03P_6	W2			
6	IO_L03N_6/VREF_6	W1			
6	IO_L05P_6	V4			
6	IO_L05N_6	V3			
6	IO_L06P_6	V2			

Table 6: **FG456/FGG456 — XC2VP2, XC2VP4, and XC2VP7**

Bank	Pin Description	Pin Number	No Connects		
			XC2VP2	XC2VP4	XC2VP7
7	VCCO_7	K7			
7	VCCO_7	J7			
7	VCCO_7	H6			
7	VCCO_7	G6			
N/A	CCLK	W20			
N/A	PROG_B	B1			
N/A	DONE	Y18			
N/A	M0	Y4			
N/A	M1	W3			
N/A	M2	Y5			
N/A	TCK	B22			
N/A	TDI	D3			
N/A	TDO	D20			
N/A	TMS	A21			
N/A	PWRDWN_B	Y19			
N/A	HSWAP_EN	A2			
N/A	RSVD	C18			
N/A	VBATT	C19			
N/A	DXP	C4			
N/A	DXN	C5			
N/A	AVCCAUXTX4	B4	NC	NC	
N/A	VTTXPAD4	B3	NC	NC	
N/A	TXNPAD4	A3	NC	NC	
N/A	TXPPAD4	A4	NC	NC	
N/A	GNDA4	C6	NC	NC	
N/A	RXPPAD4	A5	NC	NC	
N/A	RXNPAD4	A6	NC	NC	
N/A	VTRXPAD4	B5	NC	NC	
N/A	AVCCAUXRX4	B6	NC	NC	
N/A	AVCCAUXTX6	B8			
N/A	VTTXPAD6	B7			
N/A	TXNPAD6	A7			
N/A	TXPPAD6	A8			
N/A	GNDA6	C9			
N/A	RXPPAD6	A9			
N/A	RXNPAD6	A10			

Table 7: **FG676/FGG676 — XC2VP20, XC2VP30, and XC2VP40**

Bank	Pin Description	Pin Number	No Connects		
			XC2VP20	XC2VP30	XC2VP40
N/A	VCCINT	U10			
N/A	VCCINT	U11			
N/A	VCCINT	U16			
N/A	VCCINT	U17			
N/A	VCCINT	U20			
N/A	VCCINT	V9			
N/A	VCCINT	V18			
N/A	VCCINT	Y10			
N/A	VCCINT	Y13			
N/A	VCCINT	Y14			
N/A	VCCINT	Y17			
N/A	VCCAUX	A2			
N/A	VCCAUX	A13			
N/A	VCCAUX	A14			
N/A	VCCAUX	A25			
N/A	VCCAUX	N1			
N/A	VCCAUX	N26			
N/A	VCCAUX	P1			
N/A	VCCAUX	P26			
N/A	VCCAUX	AF2			
N/A	VCCAUX	AF13			
N/A	VCCAUX	AF14			
N/A	VCCAUX	AF25			
N/A	GND	A1			
N/A	GND	A26			
N/A	GND	B2			
N/A	GND	B25			
N/A	GND	C3			
N/A	GND	C24			
N/A	GND	D4			
N/A	GND	D8			
N/A	GND	D19			
N/A	GND	D23			
N/A	GND	F10			
N/A	GND	F17			

Table 8: **FF672 — XC2VP2, XC2VP4, and XC2VP7**

Bank	Pin Description	Pin Number	No Connects		
			XC2VP2	XC2VP4	XC2VP7
7	IO_L44P_7	G24	NC		
7	IO_L44N_7	G23	NC		
7	IO_L43P_7	G22	NC		
7	IO_L43N_7	G21	NC		
7	IO_L42P_7	F25	NC	NC	NC
7	IO_L42N_7	F24	NC	NC	NC
7	IO_L40P_7	F23	NC	NC	NC
7	IO_L40N_7/VREF_7	F22	NC	NC	NC
7	IO_L06P_7	E26			
7	IO_L06N_7	E25			
7	IO_L05P_7	E24			
7	IO_L05N_7	E23			
7	IO_L04P_7	D26			
7	IO_L04N_7/VREF_7	D25			
7	IO_L03P_7	C26			
7	IO_L03N_7	C25			
7	IO_L02P_7	B26			
7	IO_L02N_7	A25			
7	IO_L01P_7/VRN_7	D24			
7	IO_L01N_7/VRP_7	C23			
0	VCCO_0	C17			
0	VCCO_0	C20			
0	VCCO_0	H17			
0	VCCO_0	H18			
0	VCCO_0	J14			
0	VCCO_0	J15			
0	VCCO_0	J16			
1	VCCO_1	C7			
1	VCCO_1	H9			
1	VCCO_1	C10			
1	VCCO_1	H10			
1	VCCO_1	J11			
1	VCCO_1	J12			
1	VCCO_1	J13			
2	VCCO_2	G2			
2	VCCO_2	J8			

Table 9: **FF896 — XC2VP7, XC2VP20, XC2VPX20, and XC2VP30**

Bank	Pin Description		Pin Number	No Connects		
	Virtex-II Pro devices	XC2VPX20 (if Different)		XC2VP7	XC2VP20, XC2VPX20	XC2VP30
N/A	TXPPAD19		AK19			
N/A	TXNPAD19		AK20			
N/A	VTTXPAD19		AJ20			
N/A	AVCCAUXTX19		AJ19			
N/A	AVCCAUXRX21		AJ24			
N/A	VTRXPAD21		AJ25			
N/A	RXNPAD21		AK24			
N/A	RXPPAD21		AK25			
N/A	GNDA21		AH25			
N/A	TXPPAD21		AK26			
N/A	TXNPAD21		AK27			
N/A	VTTXPAD21		AJ27			
N/A	AVCCAUXTX21		AJ26			
N/A	VCCAUX		AK29			
N/A	VCCAUX		AK16			
N/A	VCCAUX		AK15			
N/A	VCCAUX		AK2			
N/A	VCCAUX		AJ30			
N/A	VCCAUX		AJ1			
N/A	VCCAUX		T30			
N/A	VCCAUX		T1			
N/A	VCCAUX		R30			
N/A	VCCAUX		R1			
N/A	VCCAUX		B30			
N/A	VCCAUX		B1			
N/A	VCCAUX		A29			
N/A	VCCAUX		A16			
N/A	VCCAUX		A15			
N/A	VCCAUX		A2			
N/A	VCCINT		Y19			
N/A	VCCINT		Y18			
N/A	VCCINT		Y17			
N/A	VCCINT		Y16			
N/A	VCCINT		Y15			
N/A	VCCINT		Y14			

Table 10: **FF1152 — XC2VP20, XC2VP30, XC2VP40, and XC2VP50**

Bank	Pin Description	Pin Number	No Connects			
			XC2VP20	XC2VP30	XC2VP40	XC2VP50
0	IO_L43P_0	E22				
0	IO_L44N_0	E25				
0	IO_L44P_0	D25				
0	IO_L45N_0	H21				
0	IO_L45P_0/VREF_0	G21				
0	IO_L46N_0	D22				
0	IO_L46P_0	D23				
0	IO_L47N_0	D24				
0	IO_L47P_0	C24				
0	IO_L48N_0	K20				
0	IO_L48P_0	J20				
0	IO_L49N_0	F21				
0	IO_L49P_0	E21				
0	IO_L50_0/No_Pair	C21				
0	IO_L53_0/No_Pair	C22				
0	IO_L54N_0	L19				
0	IO_L54P_0	K19				
0	IO_L55N_0	G20				
0	IO_L55P_0	F20				
0	IO_L56N_0	D21				
0	IO_L56P_0	D20				
0	IO_L57N_0	J19				
0	IO_L57P_0/VREF_0	H19				
0	IO_L67N_0	G19				
0	IO_L67P_0	F19				
0	IO_L68N_0	E19				
0	IO_L68P_0	D19				
0	IO_L69N_0	L18				
0	IO_L69P_0/VREF_0	K18				
0	IO_L73N_0	G18				
0	IO_L73P_0	F18				
0	IO_L74N_0/GCLK7P	E18				
0	IO_L74P_0/GCLK6S	D18				
0	IO_L75N_0/GCLK5P	J18				
0	IO_L75P_0/GCLK4S	H18				
1	IO_L75N_1/GCLK3P	H17				
1	IO_L75P_1/GCLK2S	J17				

Table 11: **FF1148 — XC2VP40 and XC2VP50**

Bank	Pin Description	Pin Number	No Connects	
			XC2VP40	XC2VP50
1	IO_L43P_1	B13		
1	IO_L39N_1	G13		
1	IO_L39P_1	F13		
1	IO_L38N_1	J15		
1	IO_L38P_1	J14		
1	IO_L37N_1	B12		
1	IO_L37P_1	A12		
1	IO_L27N_1/VREF_1	D13		
1	IO_L27P_1	D12		
1	IO_L26N_1	L13		
1	IO_L26P_1	K13		
1	IO_L25N_1	F12		
1	IO_L25P_1	E12		
1	IO_L21N_1	B11		
1	IO_L21P_1	A11		
1	IO_L20N_1	K12		
1	IO_L20P_1	J12		
1	IO_L19N_1	C12		
1	IO_L19P_1	C11		
1	IO_L09N_1/VREF_1	F11		
1	IO_L09P_1	E11		
1	IO_L08N_1	H13		
1	IO_L08P_1	H12		
1	IO_L07N_1	G12		
1	IO_L07P_1	G11		
1	IO_L06N_1	B10		
1	IO_L06P_1	A10		
1	IO_L05_1/No_Pair	G10		
1	IO_L03N_1/VREF_1	D10		
1	IO_L03P_1	C10		
1	IO_L02N_1	K11		
1	IO_L02P_1	J11		
1	IO_L01N_1/VRP_1	F10		
1	IO_L01P_1/VRN_1	E10		
2	IO_L01N_2/VRP_2	B8		
2	IO_L01P_2/VRN_2	B9		
2	IO_L02N_2	C9		

Table 11: **FF1148 — XC2VP40 and XC2VP50**

Bank	Pin Description	Pin Number	No Connects	
			XC2VP40	XC2VP50
6	IO_L87N_6/VREF_6	V33		
6	IO_L88P_6	V30		
6	IO_L88N_6	V31		
6	IO_L89P_6	V24		
6	IO_L89N_6	V25		
6	IO_L90P_6	V28		
6	IO_L90N_6	V29		
7	IO_L90P_7	U32		
7	IO_L90N_7	V32		
7	IO_L89P_7	U28		
7	IO_L89N_7	U29		
7	IO_L88P_7	U30		
7	IO_L88N_7/VREF_7	U31		
7	IO_L87P_7	T33		
7	IO_L87N_7	U33		
7	IO_L86P_7	U26		
7	IO_L86N_7	U27		
7	IO_L85P_7	T31		
7	IO_L85N_7	T32		
7	IO_L60P_7	R33		
7	IO_L60N_7	R34		
7	IO_L59P_7	U24		
7	IO_L59N_7	U25		
7	IO_L58P_7	R29		
7	IO_L58N_7/VREF_7	R30		
7	IO_L57P_7	P33		
7	IO_L57N_7	P34		
7	IO_L56P_7	T28		
7	IO_L56N_7	T29		
7	IO_L55P_7	P32		
7	IO_L55N_7	R32		
7	IO_L54P_7	P29		
7	IO_L54N_7	P30		
7	IO_L53P_7	T24		
7	IO_L53N_7	T25		
7	IO_L52P_7	N32		
7	IO_L52N_7/VREF_7	N33		

Table 11: **FF1148 — XC2VP40 and XC2VP50**

Bank	Pin Description	Pin Number	No Connects	
			XC2VP40	XC2VP50
1	VCCO_1	H15		
1	VCCO_1	D15		
1	VCCO_1	M14		
1	VCCO_1	M13		
1	VCCO_1	L12		
1	VCCO_1	H11		
1	VCCO_1	D11		
0	VCCO_0	H24		
0	VCCO_0	D24		
0	VCCO_0	L23		
0	VCCO_0	M22		
0	VCCO_0	M21		
0	VCCO_0	M20		
0	VCCO_0	H20		
0	VCCO_0	D20		
0	VCCO_0	M19		
0	VCCO_0	M18		
N/A	CCLK	AG9		
N/A	PROG_B	G26		
N/A	DONE	AF10		
N/A	M0	AG25		
N/A	M1	AG26		
N/A	M2	AF25		
N/A	TCK	G9		
N/A	TDI	F26		
N/A	TDO	F9		
N/A	TMS	H10		
N/A	PWRDWN_B	AG10		
N/A	HSWAP_EN	H25		
N/A	RSVD	H9		
N/A	VBATT	J10		
N/A	DXP	J25		
N/A	DXN	H26		
N/A	VCCINT	AD24		
N/A	VCCINT	L24		
N/A	VCCINT	AC23		

Table 12: **FF1517 — XC2VP50 and XC2VP70**

Bank	Pin Description	Pin Number	No Connects	
			XC2VP50	XC2VP70
6	IO_L53P_6	AB30		
6	IO_L53N_6	AB31		
6	IO_L54P_6	AC38		
6	IO_L54N_6	AC39		
6	IO_L55P_6	AC34		
6	IO_L55N_6	AC35		
6	IO_L56P_6	AA28		
6	IO_L56N_6	AA29		
6	IO_L57P_6	AB38		
6	IO_L57N_6/VREF_6	AB39		
6	IO_L58P_6	AB36		
6	IO_L58N_6	AB37		
6	IO_L59P_6	AA30		
6	IO_L59N_6	AA31		
6	IO_L60P_6	AB34		
6	IO_L60N_6	AB35		
6	IO_L85P_6	AB32		
6	IO_L85N_6	AB33		
6	IO_L86P_6	AA27		
6	IO_L86N_6	Y27		
6	IO_L87P_6	AA36		
6	IO_L87N_6/VREF_6	AA37		
6	IO_L88P_6	AA34		
6	IO_L88N_6	AA35		
6	IO_L89P_6	Y28		
6	IO_L89N_6	Y29		
6	IO_L90P_6	AA32		
6	IO_L90N_6	AA33		
7	IO_L90P_7	Y36		
7	IO_L90N_7	Y37		
7	IO_L89P_7	Y31		
7	IO_L89N_7	W31		
7	IO_L88P_7	Y32		
7	IO_L88N_7/VREF_7	Y33		
7	IO_L87P_7	W36		
7	IO_L87N_7	W37		
7	IO_L86P_7	W27		

Table 12: **FF1517 — XC2VP50 and XC2VP70**

Bank	Pin Description	Pin Number	No Connects	
			XC2VP50	XC2VP70
N/A	VCCINT	R17		
N/A	VCCINT	AE16		
N/A	VCCINT	AD16		
N/A	VCCINT	T16		
N/A	VCCINT	R16		
N/A	VCCINT	AE15		
N/A	VCCINT	AD15		
N/A	VCCINT	AC15		
N/A	VCCINT	AB15		
N/A	VCCINT	AA15		
N/A	VCCINT	Y15		
N/A	VCCINT	W15		
N/A	VCCINT	V15		
N/A	VCCINT	U15		
N/A	VCCINT	T15		
N/A	VCCINT	R15		
N/A	VCCINT	AF14		
N/A	VCCINT	P14		
N/A	VCCINT	AG13		
N/A	VCCINT	N13		
N/A	VCCINT	AH12		
N/A	VCCINT	M12		
N/A	VCCAUX	AV39		
N/A	VCCAUX	AA39		
N/A	VCCAUX	Y39		
N/A	VCCAUX	W39		
N/A	VCCAUX	B39		
N/A	VCCAUX	AW38		
N/A	VCCAUX	Y38		
N/A	VCCAUX	A38		
N/A	VCCAUX	AR35		
N/A	VCCAUX	E35		
N/A	VCCAUX	AP34		
N/A	VCCAUX	F34		
N/A	VCCAUX	AW20		
N/A	VCCAUX	AV20		
N/A	VCCAUX	B20		
N/A	VCCAUX	A20		

Table 13: **FF1704 — XC2VP70, XC2VPX70, and XC2VP100**

Bank	Pin Description		Pin Number	No Connects	
	Virtex-II Pro Devices	XC2VPX70 (if Different)		XC2VP70, XC2VPX70	XC2VP100
7	IO_L27P_7		P33		
7	IO_L27N_7		P34		
7	IO_L26P_7		N31		
7	IO_L26N_7		N32		
7	IO_L25P_7		N41		
7	IO_L25N_7		N42		
7	IO_L24P_7		N39		
7	IO_L24N_7		N40		
7	IO_L23P_7		N33		
7	IO_L23N_7		N34		
7	IO_L22P_7		N37		
7	IO_L22N_7/VREF_7		N38		
7	IO_L21P_7		N35		
7	IO_L21N_7		N36		
7	IO_L20P_7		M38		
7	IO_L20N_7		M39		
7	IO_L19P_7		M40		
7	IO_L19N_7		M41		
7	IO_L18P_7		M33		
7	IO_L18N_7		M34		
7	IO_L17P_7		M31		
7	IO_L17N_7		M32		
7	IO_L16P_7		M35		
7	IO_L16N_7/VREF_7		M36		
7	IO_L15P_7		L41		
7	IO_L15N_7		L42		
7	IO_L14P_7		L39		
7	IO_L14N_7		L38		
7	IO_L13P_7		L40		
7	IO_L13N_7		K40		
7	IO_L12P_7		L36		
7	IO_L12N_7		L37		
7	IO_L11P_7		L34		
7	IO_L11N_7		L35		
7	IO_L10P_7		K42		
7	IO_L10N_7/VREF_7		K41		

Table 14: **FF1696 — XC2VP100**

Bank	Pin Description	Pin Number	No Connects
			XC2VP100
6	IO_L52P_6	AF40	
6	IO_L52N_6	AF41	
6	IO_L53P_6	AC36	
6	IO_L53N_6	AC37	
6	IO_L54P_6	AE41	
6	IO_L54N_6	AE42	
6	IO_L55P_6	AE40	
6	IO_L55N_6	AD40	
6	IO_L56P_6	AC31	
6	IO_L56N_6	AC32	
6	IO_L57P_6	AE38	
6	IO_L57N_6/VREF_6	AE39	
6	IO_L58P_6	AD41	
6	IO_L58N_6	AD42	
6	IO_L59P_6	AB35	
6	IO_L59N_6	AB36	
6	IO_L60P_6	AD37	
6	IO_L60N_6	AD38	
6	IO_L85P_6	AC40	
6	IO_L85N_6	AC41	
6	IO_L86P_6	AB33	
6	IO_L86N_6	AB34	
6	IO_L87P_6	AC39	
6	IO_L87N_6/VREF_6	AB39	
6	IO_L88P_6	AB40	
6	IO_L88N_6	AB41	
6	IO_L89P_6	AB31	
6	IO_L89N_6	AB32	
6	IO_L90P_6	AB37	
6	IO_L90N_6	AB38	
7	IO_L90P_7	AA40	
7	IO_L90N_7	AA41	
7	IO_L89P_7	AA35	
7	IO_L89N_7	AA36	
7	IO_L88P_7	Y39	
7	IO_L88N_7/VREF_7	AA39	